## We claim:

## **CLAIMS**

- 5 1. A method of forming a thin magnetic film of nickel-iron alloy including from 63% to 81% iron by weight, the thin magnetic film also having a coercivity  $H_C$  and a saturation flux density  $B_S$ , the method comprising the steps of:
  - (a) preparing a substrate surface;
- (b) preparing an aqueous plating solution having more than four and less 10 than seven Ni<sup>++</sup> ions for each Fe<sup>++</sup> ion;
  - (c) maintaining the temperature of the aqueous solution below 20°C;
  - (c) passing from the substrate surface a current through the aqueous plating solution to an anode to form an electroplated layer on the substrate surface; and
- 15 (d) annealing the electroplated layer in the presence of an external magnetic field  $H_{\rm EXT}$ .
  - 2. The method of claim 1 wherein the preparing step (a) comprises the step of:
- 20 (a.1) forming a ferromagnetic seed layer on the substrate surface.
  - 3. The method of claim 2 wherein the ferromagnetic seed layer comprises a material selected from a group consisting of:
- a nickel-iron (NiFe) alloy, an iron-nitride-X (FeNX) alloy and a cobalt-iron-X (CoFeX) alloy wherein X comprises a material selected from a group comprising nickel, nitrogen, aluminum, rhodium and tantalum.
  - 4. The method of claim 3 wherein the ferromagnetic seed layer consists substantially of a nickel-iron alloy containing from 64% to 81% iron by weight.

25

5. The method of claim 2 wherein the ferromagnetic seed layer is formed by a process selected from a group including:

sputtering, ion beam deposition, and vacuum deposition.

- 5 6. The method of claim 5 wherein the anneal step (d) comprises the steps of:
  - (d.1) heating the electroplated layer to a temperature of from  $225\,^{\circ}\mathrm{C}$  to  $275\,^{\circ}\mathrm{C}$ ; and
- (d.2) setting the external magnetic field intensity,  $H_{EXT}$ , to 64 kA/m oriented along the easy axis of the electroplated layer
  - 7. The method of claim 2 wherein the aqueous plating solution includes from 0.06 moles/liter to 0.17 moles/liter of Fe<sup>++</sup> ions.
- 8. The method of claim 2 wherein the passing step (c) comprises the step of:

  passing in from the substrate surface a current of from about 50 A/m² to 150

  A/m² through the aqueous plating solution to an anode.
- 20 9. The method of claim 1 wherein the preparing step (b) comprises the steps of:
  - (b.1) dissolving from about 10 to about 25 g/l ferrous sulfate heptahydrate in the aqueous plating solution;
  - (b.2) dissolving from about 10 to about 25 g/l nickel sulfate hexahydrate in the aqueous plating solution; and
    - (b.3) dissolving from about 30 to about 45 g/l nickel chloride hexahydrate in the aqueous plating solution.

- 10. The method of claim 9 wherein the annealing step (d) comprises the steps of:
- (d.1) heating the electroplated layer to a temperature of from about 225°C to 275°C for no less than about 2 hours; and
- 5 (d.2) setting the external magnetic field intensity  $H_{EXT}$  to about 64 kA/m oriented along the easy axis of the electroplated layer.
  - 11. The method of claim 1 wherein the annealing step (d) comprises the steps of:
- 10 (d.1) heating the electroplated layer to a temperature of from about  $225\,^{\circ}\text{C}$  to  $275\,^{\circ}\text{C}$  for no less than 2 hours; and
  - $(d.2) \quad \text{setting the external magnetic field intensity $H_{EXT}$ to 64 kA/m oriented along the easy axis of the electroplated layer.}$
- 15 12. The method of claim 1 wherein the coercivity  $H_C$  is less than about 160 A/m and the saturation flux density  $B_S$  is more than 1.9 teslas.
  - 13. The method of claim 1 wherein the aqueous plating solution includes from 0.06 moles/liter to 0.17 moles/liter of Fe<sup>++</sup> ions.
  - 14. The method of claim 1 wherein the passing step (c) comprises the step of:

passing in from the substrate surface a current of from  $50~\text{A/m}^2$  to  $150~\text{A/m}^2$  through the aqueous plating solution to an anode.

20